

TFT DISPLAY SPECIFICATION



WINSTAR Display Co.,Ltd.
華凌光電股份有限公司



Winstar Display Co., LTD

華凌光電股份有限公司



WEB: <https://www.winstar.com.tw> E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER : _____

MODULE NO.: **WF70A2TIAGDNN0#**

APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION: DATA:
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SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			周园园
ISSUED DATE: 2024/07/31			

TFT Display Inspection Specification: <https://www.winstar.com.tw/technology/download.html>

Precaution in use of TFT module: <https://www.winstar.com.tw/technology/download/declaration.html>

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2018/05/21		First issue
A	2018/08/15		Add Uniformity
B	2021/05/10		Modify interface
C	2021/06/15		Added the AVDD in min. and max. value
D	2022/08/25		Add TFT Driver IC& TFT Interface
E	2024/07/31		Modify AC Characteristics Modify Interface Modify Electrical Characteristics

Contents

1.Module Classification Information

2.Summary

3.General Specifications

4.Absolute Maximum Ratings

5.Electrical Characteristics

6.DC Characteristics

7.AC Characteristics

8.Optical Characteristics

9.Interface

10.Block Diagram

11.Reliability

12.Contour Drawing

13.Other

1.Module Classification Information

W F 70 A2 T I A G D N N 0 #
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

①	Brand : WINSTAR DISPLAY CORPORATION																																																																							
②	Display Type : F→TFT Type, J→Custom TFT																																																																							
③	Display Size : 7.0” TFT																																																																							
④	Model serials no.																																																																							
⑤	Backlight Type :	F→CCFL, White S→LED, High Light White						T→LED, White Z→Nichia LED, White																																																																
⑥	LCD Polarize Type/ Temperature range/ Gray Scale Inversion Direction	A→Transmissive, N.T, IPS TFT C→Transmissive, N. T, 6:00 ; F→Transmissive, N.T,12:00 ; I→Transmissive, W. T, 6:00 K→Transflective, W.T,12:00 L→Transmissive, W.T,12:00 N→Transmissive, Super W.T, 6:00						Q→Transmissive, Super W.T, 12:00 R→Transmissive, Super W.T, O-TFT V→Transmissive, Super W.T, VA TFT W→Transmissive, Super W.T, IPS TFT X→Transmissive, W.T, VA TFT Y→Transmissive, W.T, IPS TFT Z→Transmissive, W.T, O-TFT																																																																
⑦	A : TFT LCD B : TFT+SCREW HOLES+CONTROL BOARD C : TFT+ SCREW HOLES +A/D BOARD D : TFT+ SCREW HOLES +A/D BOARD+CONTROL BOARD E : TFT+ SCREW HOLES +POWER BOARD						F : TFT+CONTROL BOARD G : TFT+ SCREW HOLES H : TFT+D/V BOARD I : TFT+ SCREW HOLES +D/V BOARD J : TFT+POWER BD																																																																	
⑧	Resolution: <table><tr><td>A</td><td>128160</td><td>B</td><td>320234</td><td>C</td><td>320240</td><td>D</td><td>480234</td><td>E</td><td>480272</td><td>F</td><td>640480</td></tr><tr><td>G</td><td>800480</td><td>H</td><td>1024600</td><td>I</td><td>320480</td><td>J</td><td>240320</td><td>K</td><td>800600</td><td>L</td><td>240400</td></tr><tr><td>M</td><td>1024768</td><td>N</td><td>128128</td><td>P</td><td>1280800</td><td>Q</td><td>480800</td><td>R</td><td>640320</td><td>S</td><td>480128</td></tr><tr><td>T</td><td>800320</td><td>U</td><td>8001280</td><td>V</td><td>176220</td><td>W</td><td>1280398</td><td>X</td><td>1024250</td><td>Y</td><td>1920720</td></tr><tr><td>Z</td><td>800200</td><td>2</td><td>1024324</td><td>3</td><td>7201280</td><td>4</td><td>19201200</td><td>5</td><td>1366768</td><td>6</td><td>1280320</td></tr></table>												A	128160	B	320234	C	320240	D	480234	E	480272	F	640480	G	800480	H	1024600	I	320480	J	240320	K	800600	L	240400	M	1024768	N	128128	P	1280800	Q	480800	R	640320	S	480128	T	800320	U	8001280	V	176220	W	1280398	X	1024250	Y	1920720	Z	800200	2	1024324	3	7201280	4	19201200	5	1366768	6	1280320
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⑨	D: Digital L : LVDS M:MIPI																																																																							
⑩	Interface: <table><tr><td>N</td><td>Without control board</td><td>A</td><td>8Bit</td><td>B</td><td>16Bit</td><td>H</td><td>HDMI</td></tr><tr><td>I</td><td>I2C Interface</td><td>R</td><td>RS232</td><td>S</td><td>SPI Interface</td><td>U</td><td>USB</td></tr></table>												N	Without control board	A	8Bit	B	16Bit	H	HDMI	I	I2C Interface	R	RS232	S	SPI Interface	U	USB																																												
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⑪	TS: <table><tr><td>N</td><td>Without TS</td><td>T</td><td>Resistive touch panel</td><td>C</td><td>Capacitive touch panel (G-F-F)</td></tr><tr><td>G</td><td>Capacitive touch panel (G-G)</td><td>C1</td><td>Capacitive touch panel (G-F-F)+OCA</td></tr><tr><td>C2</td><td>Capacitive touch panel (G-F-F)+OCR</td><td>G1</td><td>Capacitive touch panel (G-G)+OCA</td></tr><tr><td>G2</td><td>Capacitive touch panel (G-G)+OCR</td><td>B</td><td>CTP+GG+USB</td></tr></table>												N	Without TS	T	Resistive touch panel	C	Capacitive touch panel (G-F-F)	G	Capacitive touch panel (G-G)	C1	Capacitive touch panel (G-F-F)+OCA	C2	Capacitive touch panel (G-F-F)+OCR	G1	Capacitive touch panel (G-G)+OCA	G2	Capacitive touch panel (G-G)+OCR	B	CTP+GG+USB																																										
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⑫	Version: X:Raspberry pi																																																																							
⑬	Special Code	#:Fit in with ROHS directive regulations																																																																						

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2.Summary

TFT 7.0" is a TN transmissive type color active matrix TFT liquid crystal display that uses amorphous silicon TFT as switching devices. This module is composed of a TFT_LCD module. It is usually designed for industrial application and this module follows RoHS.

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3.General Specifications

Item	Dimension	Unit
Size	7.0	inch
Dot Matrix	800 x RGB x 480 (TFT)	dots
Module dimension	165 x 100.0x 5.7	mm
Active area	154.08 x 85.92	mm
Pixel Pitch	0.1926 X 0.179	mm
LCD type	TFT, Normally White, Transmissive	
View Direction	12 o'clock	
Gray Scale Inversion Direction	6 o'clock	
Aspect Ratio	16:9	
Backlight Type	LED ,Normally White	
Color arrangement	RGB-STRIFE	
TFT Driver IC	ST5623D + ST5091D or equivalent	
TFT Interface	24-bit RGB	
With /Without TP	Without TP	
Surface	Anti-Glare	

*Color tone slight changed by temperature and driving voltage.

4. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C

5. Electrical Characteristics

5.1. Operating conditions:

Item	Symbol	Min	Typ	Max	Unit	Remark
Supply Voltage For Logic	VCC	3.0	3.3	3.6	V	
Power voltage	AVDD	10.2	10.4	10.6	V	
Power Supply For Current	VCC =3.3V	-	7.5	15	mA	-
Power voltage	VGH	14.5	15.0	15.5	V	-
Power voltage	VGL	-10.5	-10	-9.5	V	-
Input signal voltage	VCOM	3.54	4.04	4.54	V	Note
Power AVDD For Current	IADD	-	25	-	mA	
Power VGH For Current	IGH	-	0.2	-	mA	
Power VGL For Current	IGL	-	0.2	-	mA	
Power VCOM For Current	ICOM	-	0.7	-	mA	

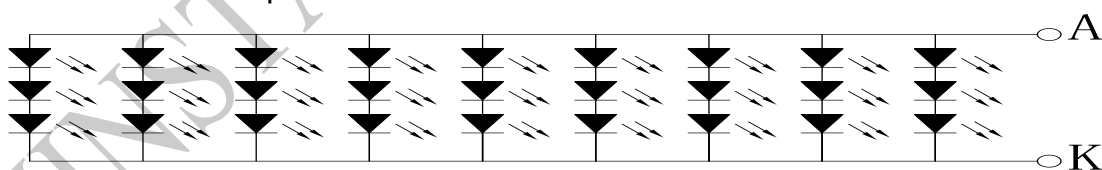
Note:

Typical VCOM is only a reference value. It must be optimized according to each LCM. Please use VR.

5.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current	-	-	180	-	mA	-
LED voltage	A~K	8.4	9.8	11.0	V	Note 1
LED Life Time	-		50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Backlight LED Circuit

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

6.DC CHARATERISTICS

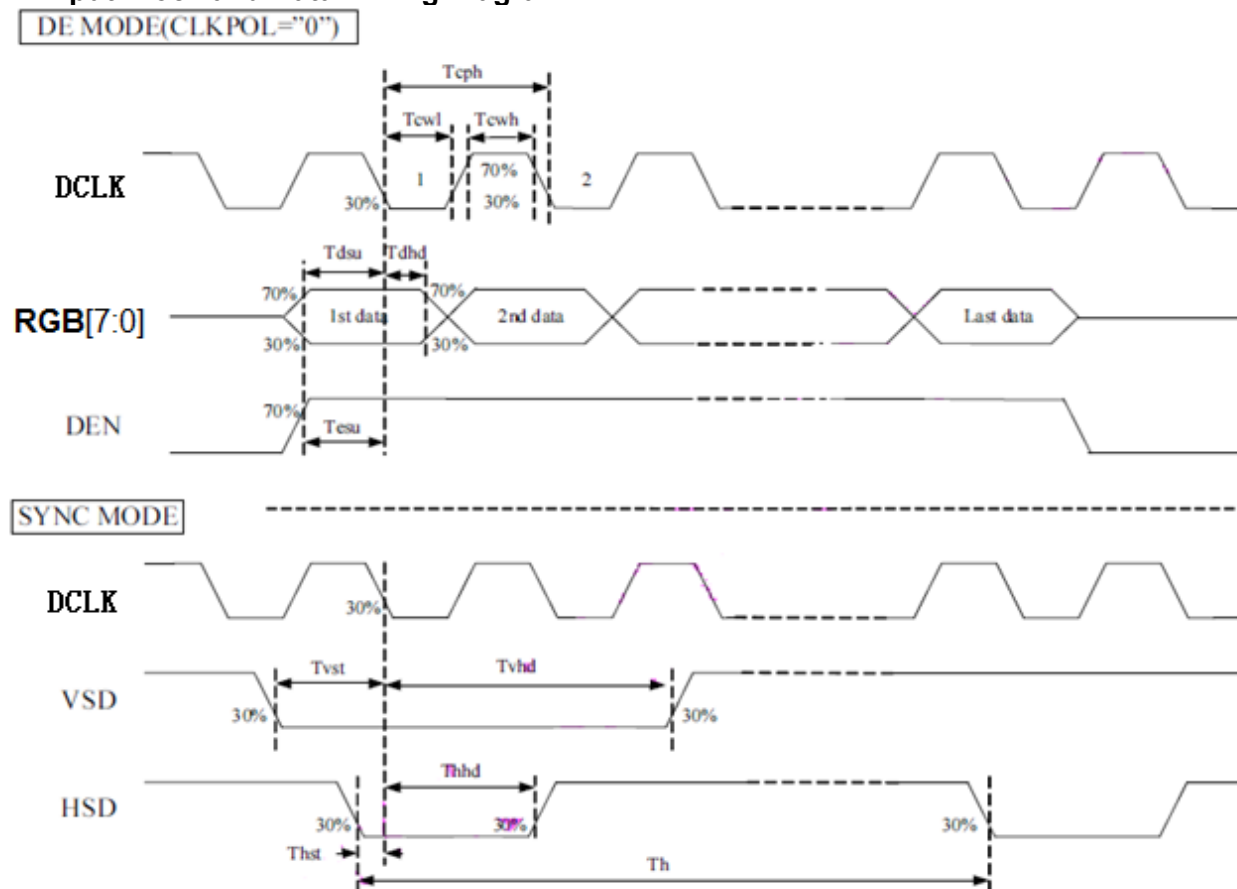
Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3VCC	V	
High level input voltage	V_{IH}	0.7VCC	-	VCC	V	

7.AC CHARACTERISTICS

7.1. AC Electrical Characteristics

Signal	Symbol	Min	Typ	Max	Unit	Conditions
VCC Power on Slew Rate	TPOR	-	-	20	ms	From 0V to 90% VCC
RSTB pulse width	TRST	10	-	-	us	Clkin=50MHz
CLKIN cycle time	Tcph	20		-	ns	
CLKIN pulse duty	Tcwh	40	50	60	%	
VSD setup time	Tvst	8	-	-	ns	
VSD hold time	Tvhd	8	-	-	ns	
HSD setup time	Thst	8	-	-	ns	
HSD hold time	Thhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	R[7:0], G[7:0], B[7:0] to clkin
Date hold time	Tdhd	8	-	-	ns	R[7:0], G[7:0], B[7:0] to clkin
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
Output stable time	Tsst	-	-	6	us	10% to 90% target voltage. CL=120pF, R=10Kohm
CLKIN Frequency	Fclk	-	40	50	MHz	VCC=3.0V~3.6V
CLKIN Cycle Time	Tclk	20	25	-	ns	
CLKIN Pulse Duty	Tcwh	40	50	60	%	Tclk
Time from HSD to Source Output	Thso	-	20	-	CLKIN	
Time from HSD to LD	Thld	-	20	-	CLKIN	
Time from HSD to STV	Thstv	-	2	-	CLKIN	
Time from HSD to CKV	Thckv	-	20	-	CLKIN	
Time from HSD to OEV	Thoev	-	4	-	CLKIN	
LD pulse width	Twld	-	10	-	CLKIN	
CKV pulse width	Twckv	-	66	-	CLKIN	
OEV pulse width	Twoev	-	74	-	CLKIN	

7.2. Input Clock and Data Timing Diagram



7.3. Timing

Horizontal input timing

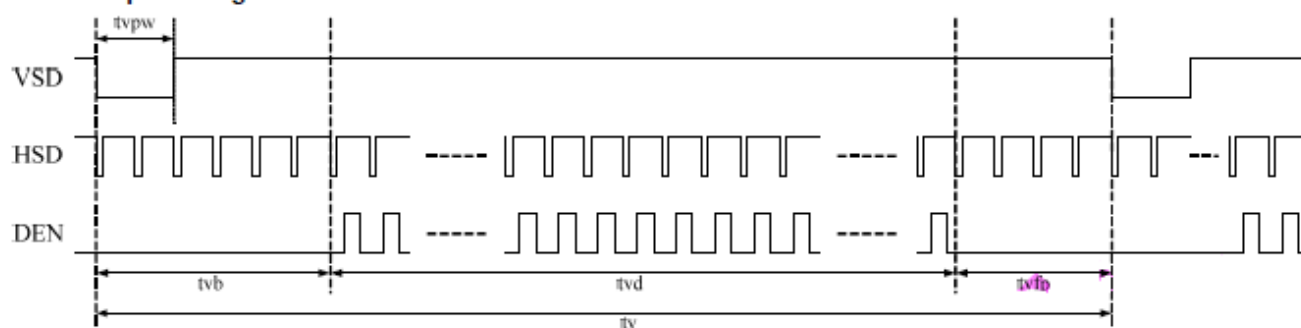
Item		Symbol	Values			Unit
Horizontal display area		thd	800			DCLK
DCLK frequency		fclk	Min.	Typ.	Max.	
			-	33.3	50	MHz
1 Horizontal Line		th	862	1056	1200	DCLK
HSD pulse width	Min.	thpw	1			
	Typ.		-			
	Max.		40			
HSD Blanking		thb	46	46	46	
HSD Front Porch		thfp	16	210	354	

Vertical input timing

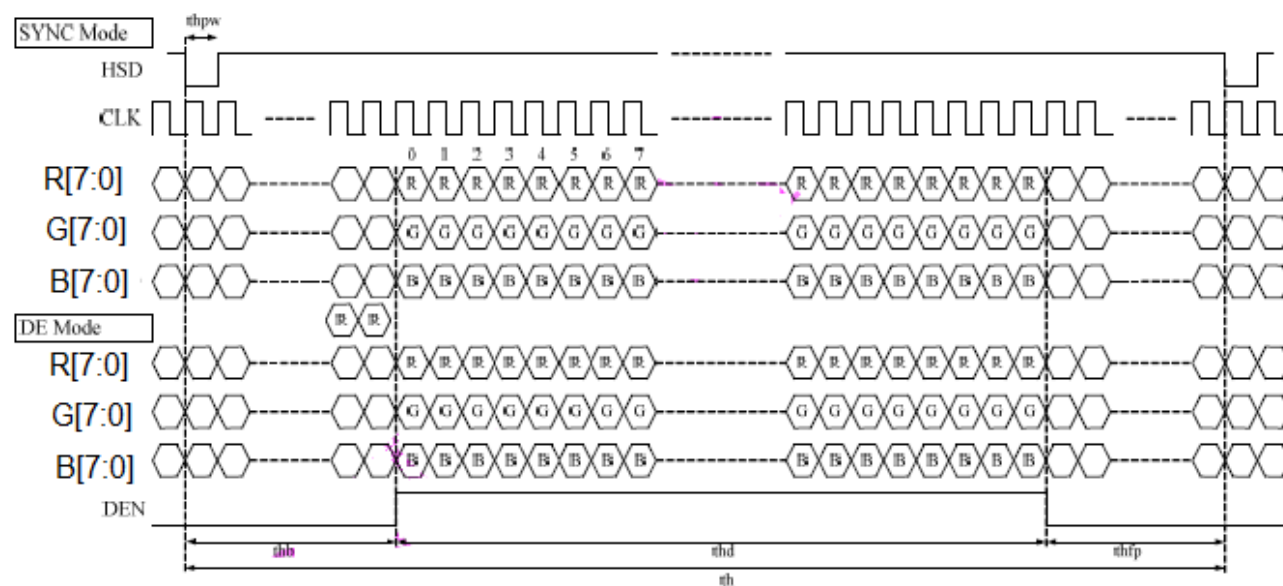
Item	Symbol	Values			Unit
		Min	Typ.	Max.	
Vertical display area	tv _d	480			H
VSD period time	tv	510	525	650	H
VSD pulse width	tv _{pw}	1	-	20	H
VSD Blanking	tv _b	23	23	23	H
VSD Front Porch	tv _{fp}	7	22	147	H

7.4. Data Input Format

Vertical input timing

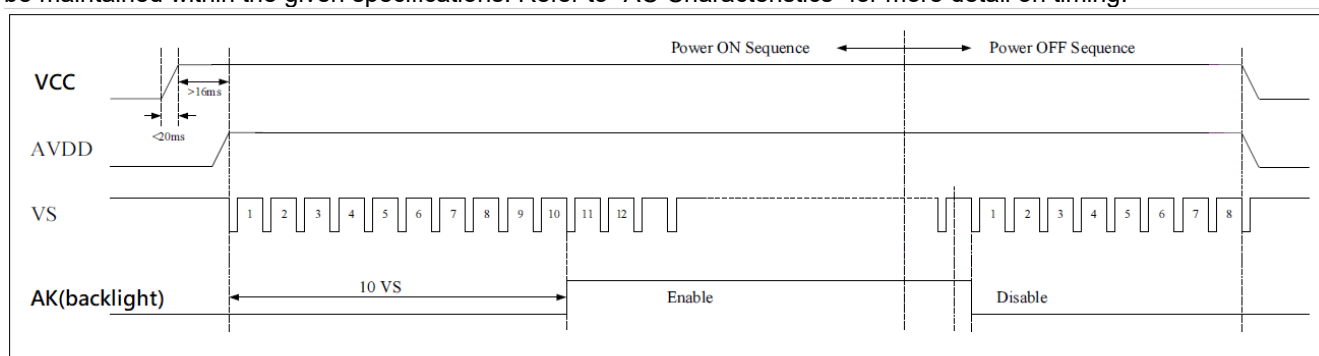


Horizontal input timing



7.5. Power Sequence

In order to prevent IC from power on reset fail, the rising time of the digital power supply VCC should be maintained within the given specifications. Refer to “AC Characteristics” for more detail on timing.



8.Optical Characteristics

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr+ Tf	$\theta=0^{\circ}$ 、 $\Phi=0^{\circ}$	-	25	50	.ms	Note 3
Contrast ratio		CR	At optimized viewing angle	500	800	-	-	Note 4
Color Chromaticity	White	Wx	$\theta=0^{\circ}$ 、 $\Phi=0$	0.26	0.31	0.36	-	Note 2,5,6
		Wy		0.28	0.33	0.38	-	
Viewing angle (Gray Scale Inversion Direction)	Hor.	ΘR	$CR \geq 10$	60	70	-	Deg.	Note 1
		ΘL		60	70	-		
	Ver.	ΦT		50	60	-		
		ΦB		60	70	-		
Brightness		-	-	320	400	-	cd/m ²	Center of display
Uniformity		(U)	-	70	-	-	%	Note 5

Ta=25±2°C, IL=180mA

Note 1: Definition of viewing angle range

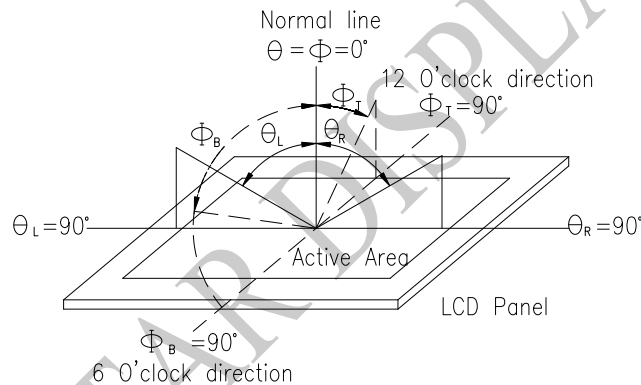


Fig. 8.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

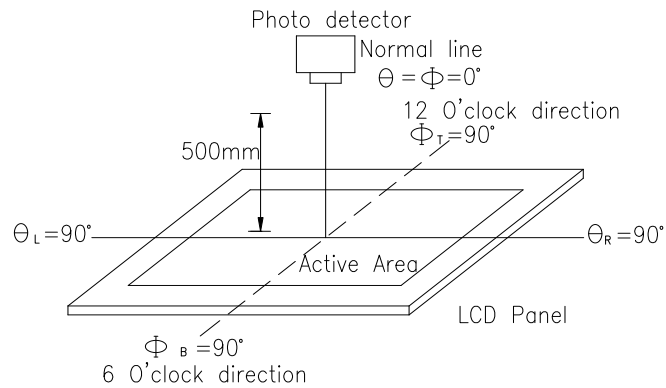
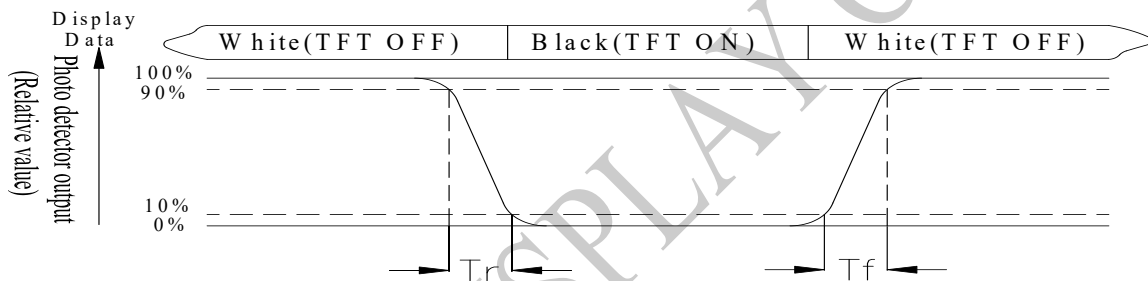


Fig. 8.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%.



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (U)} = \text{Lmin/Lmax} \times 100\%$$

L = Active area length

W = Active area width

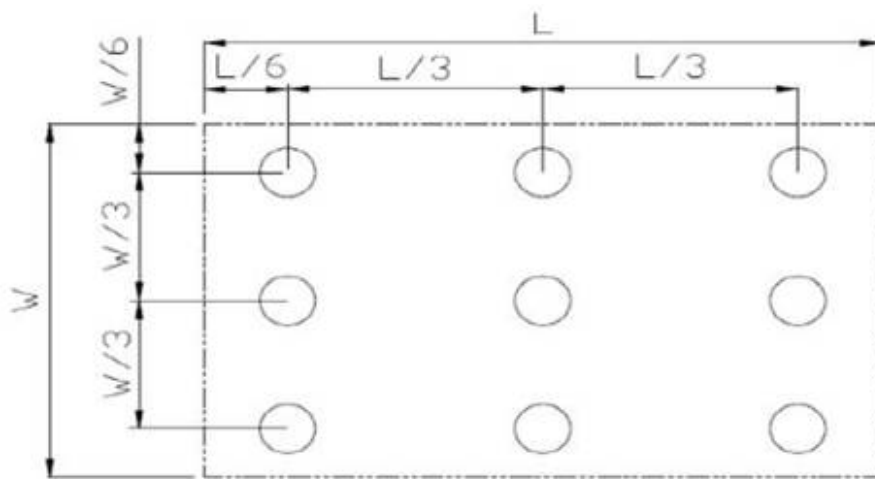


Fig8.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931)
Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

9.Interface

9.1. LCM PIN Definition

Pin	Symbol	Function	Remark
1	A	Power supply for backlight	
2	A	Power supply for backlight	
3	K	Backlight ground	
4	K	Backlight ground	
5	GND	Power ground	
6	VCOM	Common voltage	
7	VCC	Power for Digital Circuit	
8	MODE	DE/SYNC mode select	Note 1
9	DE	Data Input Enable (DEN)	
10	VS	Vertical Sync Input (VSD)	
11	HS	Horizontal Sync Input (HSD)	
12	B7	Blue data(MSB)	
13	B6	Blue data	
14	B5	Blue data	
15	B4	Blue data	
16	B3	Blue data	
17	B2	Blue data	
18	B1	Blue data	Note 2
19	B0	Blue data(LSB)	Note 2
20	G7	Green data(MSB)	
21	G6	Green data	
22	G5	Green data	
23	G4	Green data	
24	G3	Green data	
25	G2	Green data	
26	G1	Green data	Note 2
27	G0	Green data(LSB)	Note 2
28	R7	Red data(MSB)	
29	R6	Red data	
30	R5	Red data	
31	R4	Red data	

32	R3	Red data	
33	R2	Red data	
34	R1	Red data	Note 2
35	R0	Red data(LSB)	Note 2
36	GND	Power Ground	
37	DCLK	Sample clock (CLK)	Note 3
38	GND	Power Ground	
39	L/R	Left / right selection	Note 4,5
40	U/D	Up/down selection	Note 4,5
41	VGH	Gate ON Voltage	
42	VGL	Gate OFF Voltage	
43	AVDD	Power for Analog Circuit	
44	RESET	Global reset pin.	Note 6
45	NC	No connection	
46	VCOM	Common Voltage	
47	DITHB	Dithering function	Note 7
48	GND	Power Ground	
49	NC	No connection	
50	NC	No connection	

I: input, O: output, P: Power

Note 1: When select DE mode, MODE="1", VS and HS must pull high.

When select SYNC mode, MODE= "0", DE must be grounded.

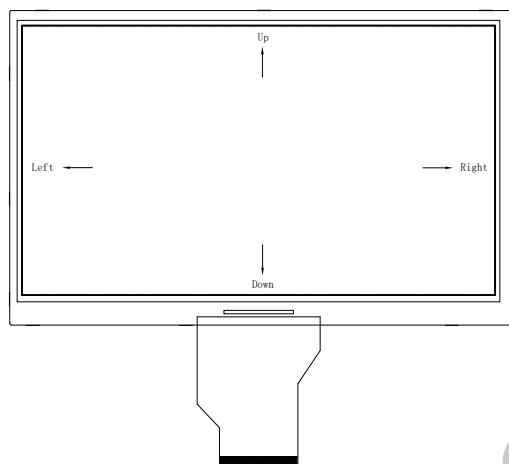
Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

Note 3: Data shall be latched at the falling edge of DCLK.

Note 4: Selection of scanning mode

Setting of scan control input		Scanning direction
U/D	L/R	
Low	High	Up to down, left to right
High	Low	Down to up, right to left
Low	Low	Up to down, right to left
High	High	Down to up, left to right

Note 5: Definition of scanning direction.
Refer to the figure as below:

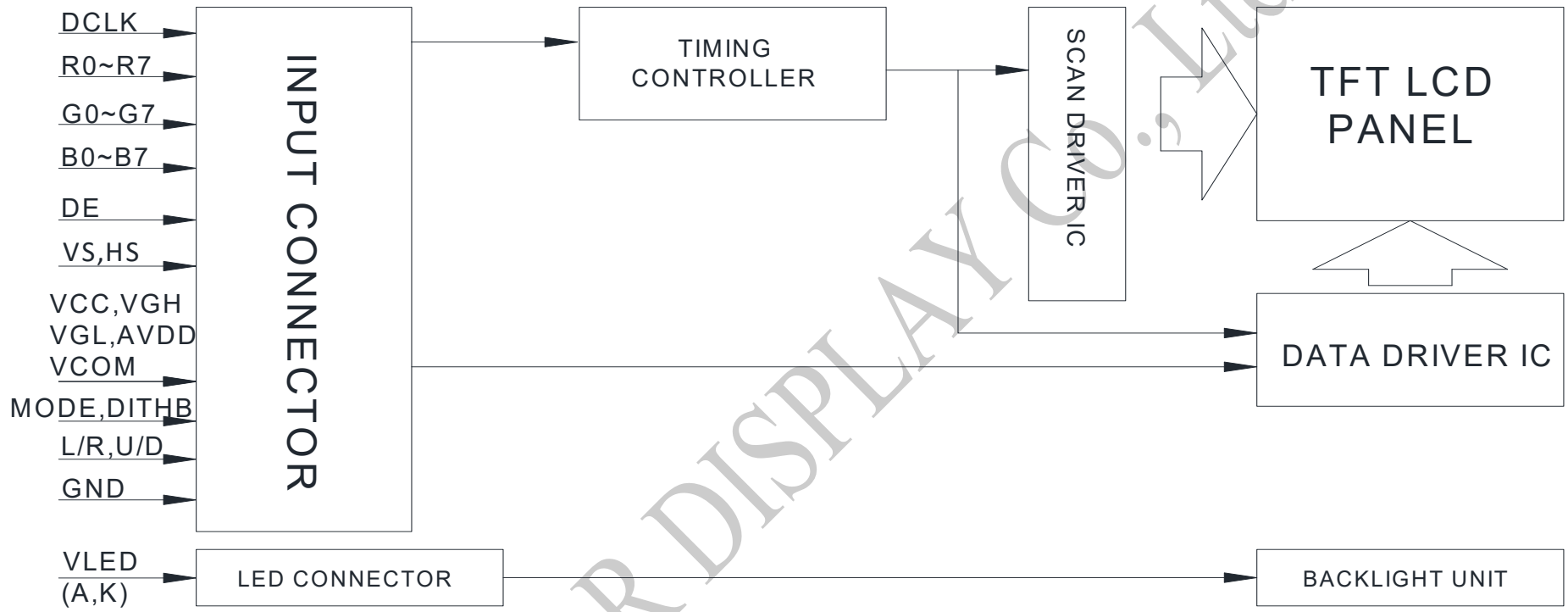


Note 6: Global reset pin. Active low to enter reset state . Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note 7: Dithering function enable control, normally pull high.

When DITHB="1", Disable internal dithering function,
When DITHB="0", Enable internal dithering function,

10. Block Diagram



11. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

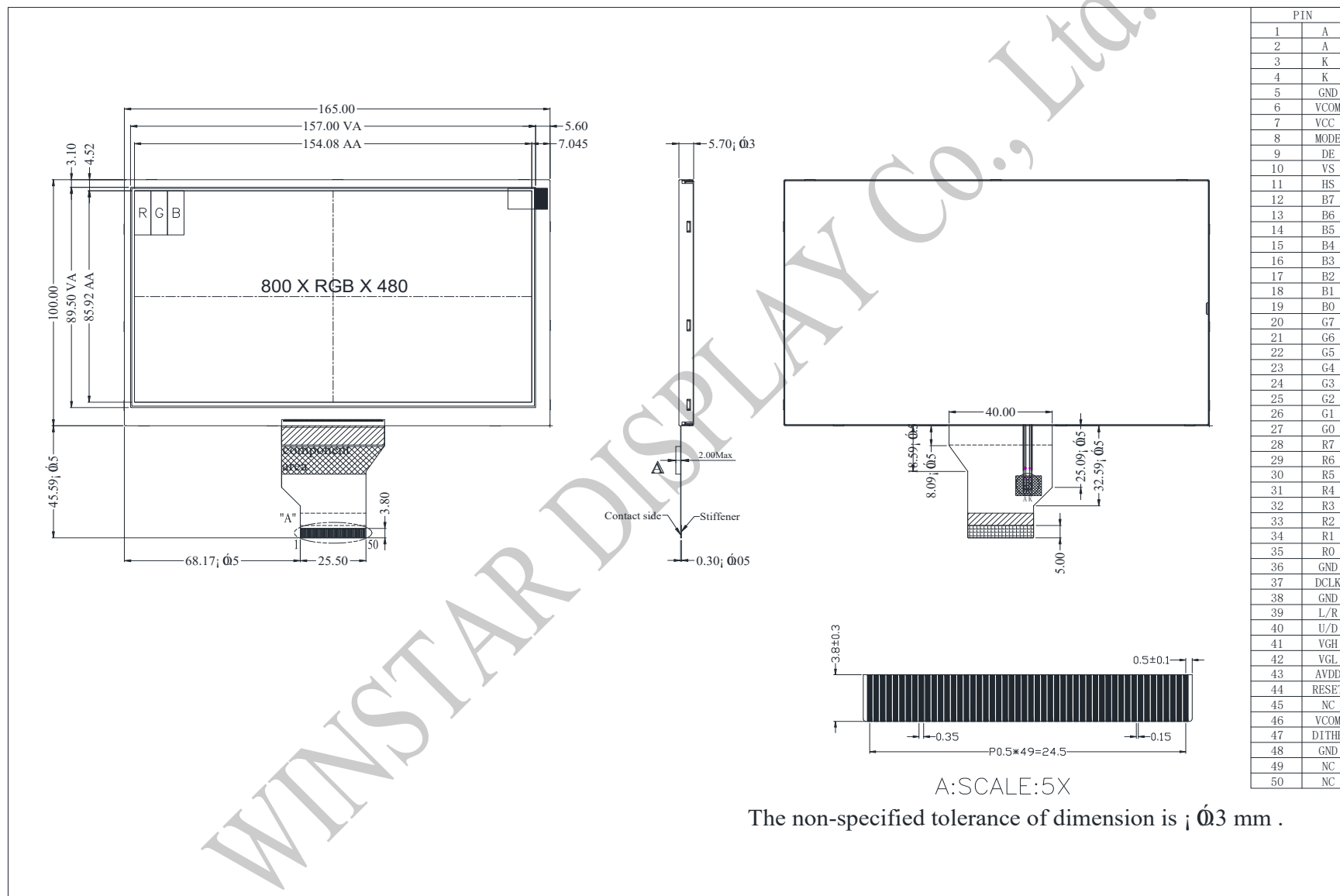
Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	—

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

12.Contour Drawing



**1、Panel Specification :**

- | | | |
|----------------------------|-------------------------------|-------------------------------------|
| 1. Panel Type : | ☐ Pass | ☐ NG , _____ |
| 2. View Direction : | ☐ Pass | ☐ NG , _____ |
| 3. Numbers of Dots : | ☐ Pass | ☐ NG , _____ |
| 4. View Area : | ☐ Pass | ☐ NG , _____ |
| 5. Active Area : | ☐ Pass | ☐ NG , _____ |
| 6. Operating Temperature : | ☐ Pass | ☐ NG , _____ |
| 7. Storage Temperature : | ☐ Pass | ☐ NG , _____ |
| 8. Others : | _____ | |

2、Mechanical

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. PCB Size : | ☐ Pass | ☐ NG , _____ |
| 2. Frame Size : | ☐ Pass | ☐ NG , _____ |
| 3. Material of Frame : | ☐ Pass | ☐ NG , _____ |
| 4. Connector Position : | ☐ Pass | ☐ NG , _____ |
| 5. Fix Hole Position : | ☐ Pass | ☐ NG , _____ |
| 6. Backlight Position : | ☐ Pass | ☐ NG , _____ |
| 7. Thickness of PCB : | ☐ Pass | ☐ NG , _____ |
| 8. Height of Frame to PCB : | ☐ Pass | ☐ NG , _____ |
| 9. Height of Module : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

3、Relative Hole Size :

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. Pitch of Connector : | ☐ Pass | ☐ NG , _____ |
| 2. Hole size of Connector : | ☐ Pass | ☐ NG , _____ |
| 3. Mounting Hole size : | ☐ Pass | ☐ NG , _____ |
| 4. Mounting Hole Type : | ☐ Pass | ☐ NG , _____ |
| 5. Others : | ☐ Pass | ☐ NG , _____ |

4、Backlight Specification :

- | | | |
|--|-------------------------------|-------------------------------------|
| 1. B/L Type : | ☐ Pass | ☐ NG , _____ |
| 2. B/L Color : | ☐ Pass | ☐ NG , _____ |
| 3. B/L Driving Voltage (Reference for LED Temperature) : | ☐ Pass | ☐ NG , _____ |
| 4. B/L Driving Current : | ☐ Pass | ☐ NG , _____ |
| 5. Brightness of B/L : | ☐ Pass | ☐ NG , _____ |
| 6. B/L Solder Method : | ☐ Pass | ☐ NG , _____ |
| 7. Others : | ☐ Pass | ☐ NG , _____ |

>> Go to page 2 <<